

# RKD751KP

## Silicon Schottky Barrier Diode for Detector

REJ03G1485-0200

Rev.2.00

Feb 22, 2007

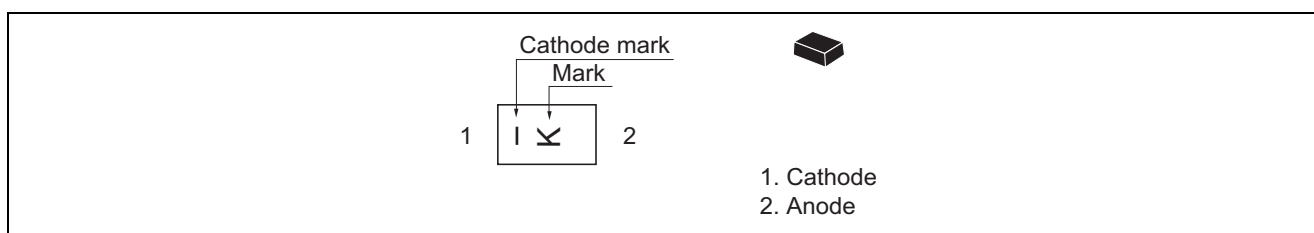
### Features

- High forward current, Low capacitance.
- Halogen free, Environmental friendly Package include Conformity to RoHS Directive.
- Ultra small Package (0.6mm×0.3mm Size leadless type)

### Ordering Information

Part No.	Laser Mark	Package Name	Package Code
RKD751KP	K	MP6	PXSN0002ZB-A

### Pin Arrangement



## Absolute Maximum Ratings

(Ta = 25°C)

Item	Symbol	Value	Unit
Repetitive peak reverse voltage	$V_{RRM}$	5	V
Reverse voltage	$V_R$	3	V
Average rectified current	$I_O$	30	mA
Junction temperature	$T_j$	125	°C
Storage temperature	$T_{stg}$	-55 to +125	°C

## Electrical Characteristics

(Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse voltage	$V_R$	3.0	—	—	V	$I_R = 1 \text{ mA}$
Reverse current	$I_R$	—	—	50	$\mu\text{A}$	$V_R = 0.5 \text{ V}$
Forward current	$I_F$	35	—	—	mA	$V_F = 0.5 \text{ V}$
Capacitance	C	—	—	1.0	pF	$V_R = 0.5 \text{ V}$ , $f = 1 \text{ MHz}$
ESD-Capability *1	—	30	—	—	V	C = 200 pF, $R_L = 0 \Omega$ , Both forward and reverse direction 1 pulse.

Notes: 1. Failure criterion ;  $I_R > 100 \mu\text{A}$  at  $V_R = 0.5 \text{ V}$ 

2. Please do not use the soldering iron due to avoid high stress to the MP6 package.

## Main Characteristics

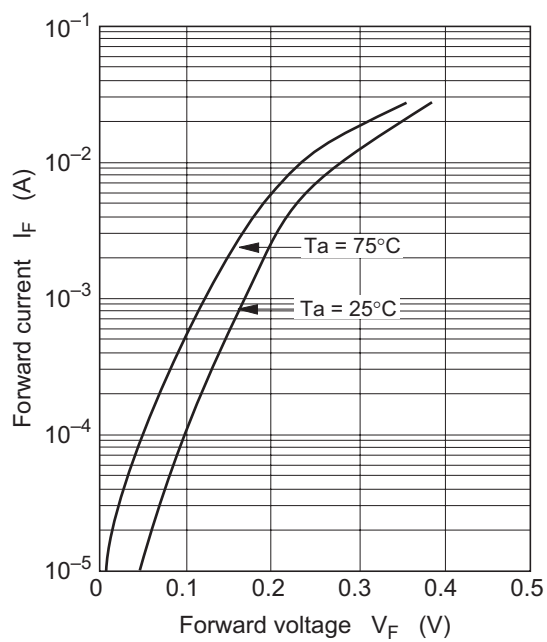


Fig.1 Forward current vs. Forward voltage

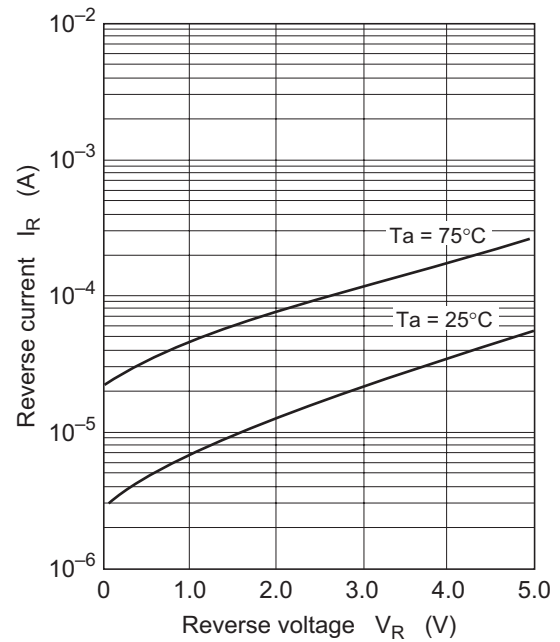


Fig.2 Reverse current vs. Reverse voltage

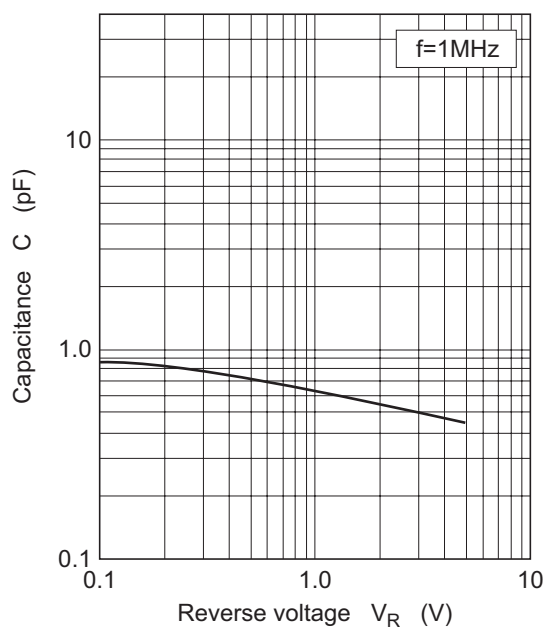
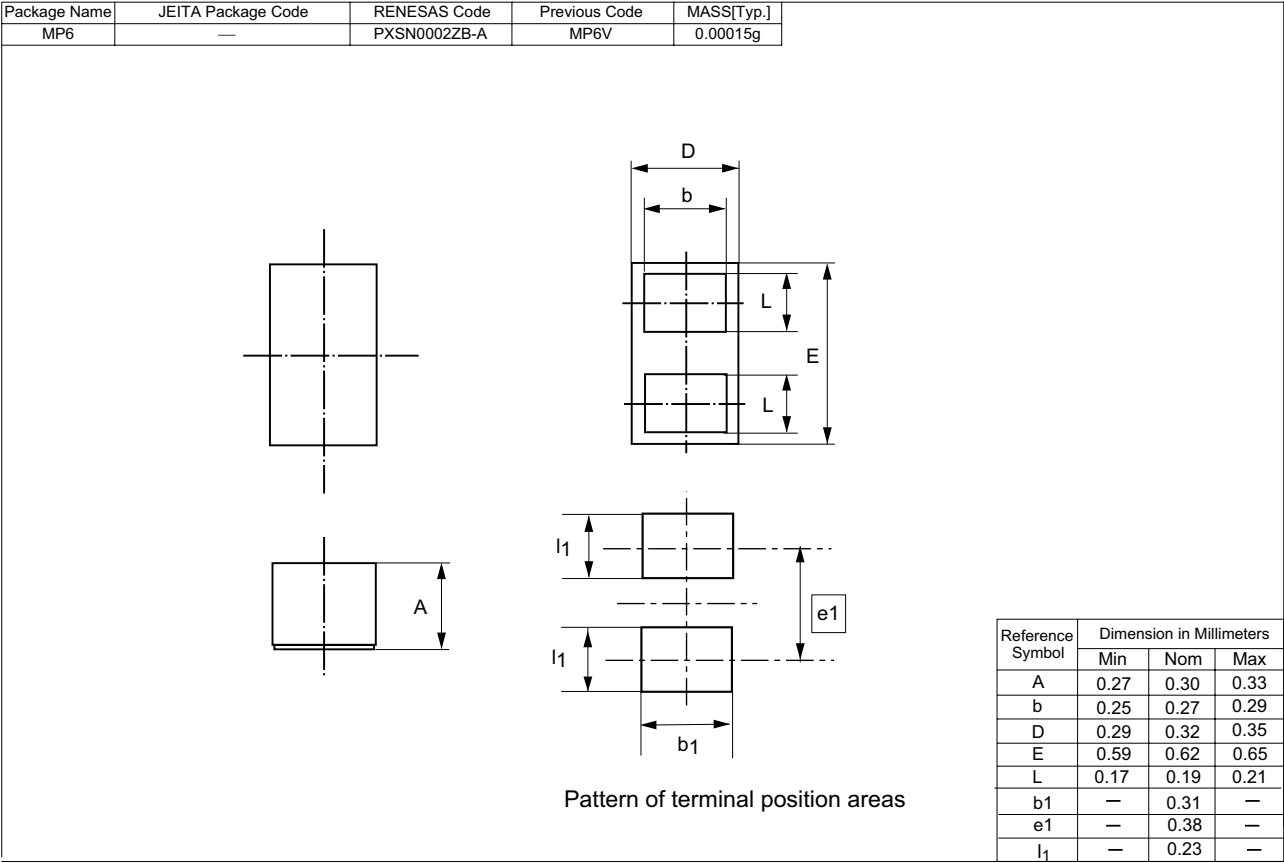


Fig.3 Capacitance vs. Reverse voltage

Package Dimensions



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